

Features

- Split Gate Trench MOSFET Technology
- Excellent Package For Heat Dissipation
- Moisture Sensitivity Level 1
- Halogen Free."Green" Device^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

N-CHANNEL MOSFET

Maximum Ratings

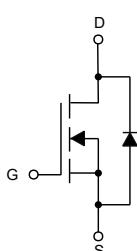
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 40°C/W Junction to Ambient^(Note2)
- Thermal Resistance: 0.4°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	220	A
T _C =100°C	139		
Pulsed Drain Current ^(Note3)	I _{DM}	880	A
Total Power Dissipation ^(Note4)	P _D	312.5	W
Avalanche Energy ^(Note5)	E _{AS}	500	mJ

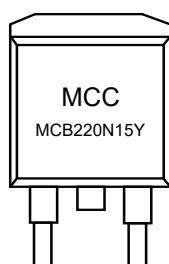
Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-case thermal resistance.
5. T_J=25°C, V_{DD}=75V, V_{GS}=10V, L=0.5mH.

Internal Structure and Marking Code

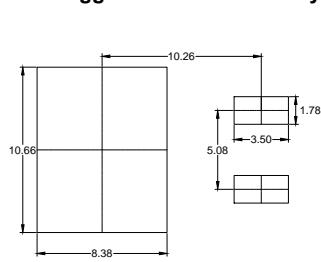


1. Gate
2,4. Drain
3. Source



D ² -PAK					NOTE	
DIM	INCHES		MM			
	MIN	MAX	MIN	MAX		
A	0.331	0.370	8.40	9.40		
B	0.378	0.417	9.60	10.60		
C	0.165	0.189	4.20	4.80		
D	0.027	0.037	0.68	0.94		
E	0.045	0.055	1.14	1.40		
G	0.10		2.54		TYP.	
H	0.096	0.134	2.43	3.40		
J	0.011	0.025	0.28	0.64		
K	0.071	0.131	1.80	3.32		
S	0.575	0.625	14.60	15.87		
V	0.042	0.058	1.07	1.47		
W	0.000	0.010	0.00	0.25		

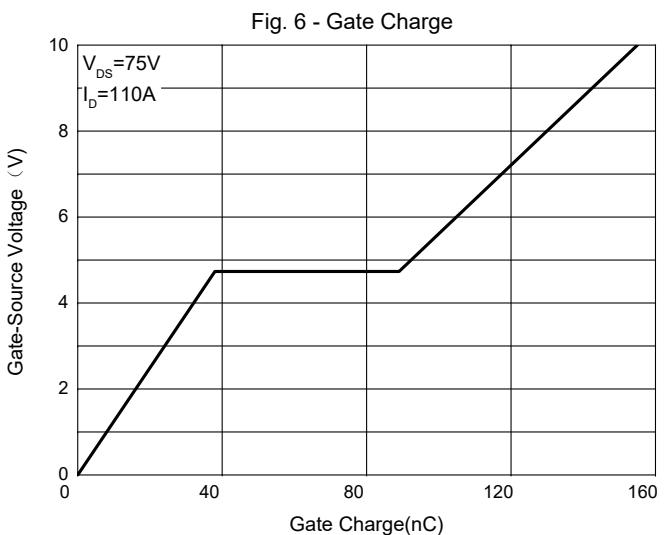
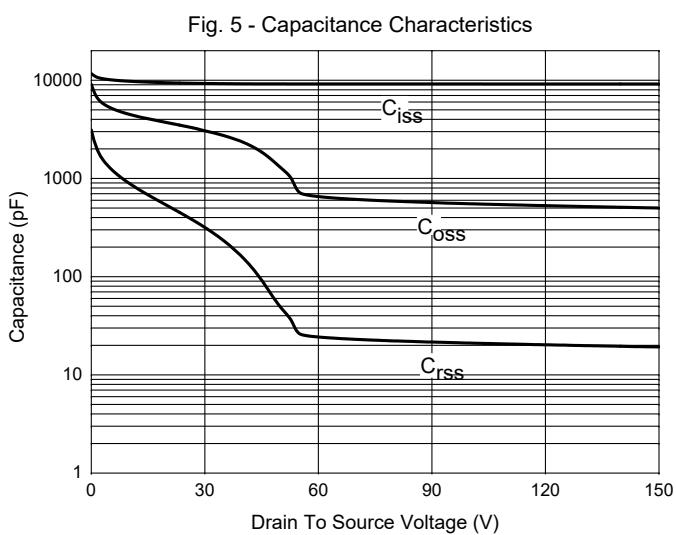
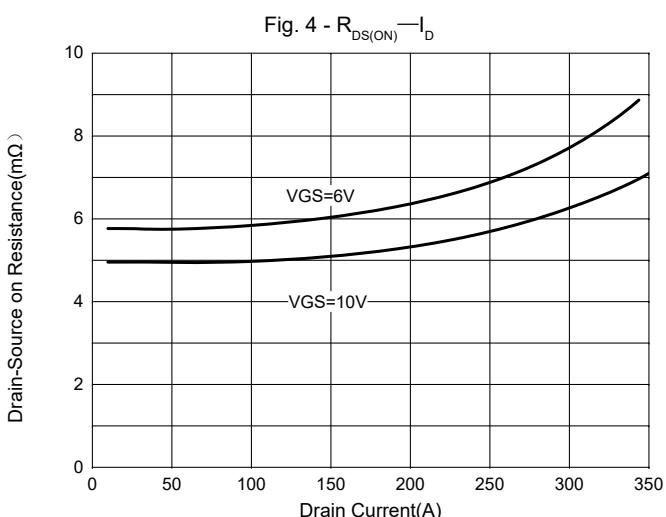
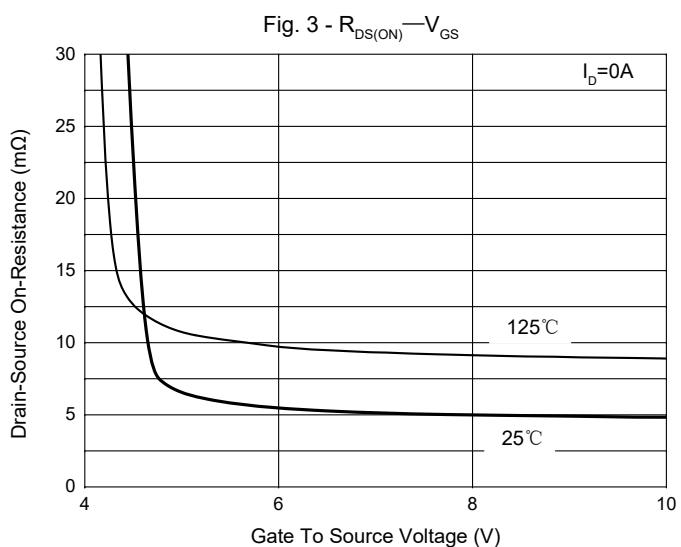
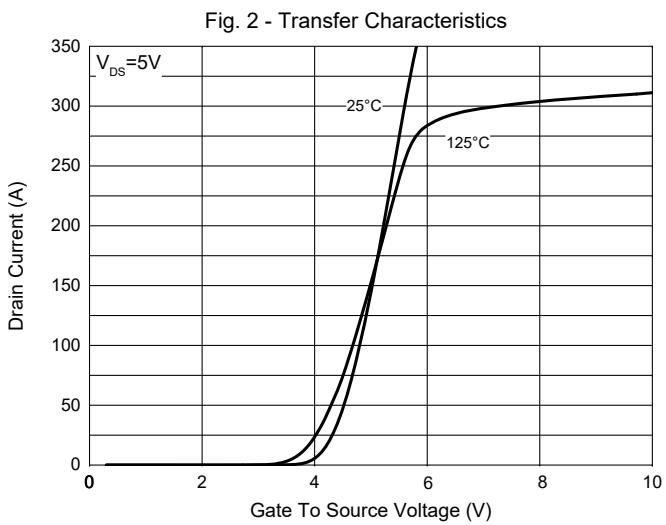
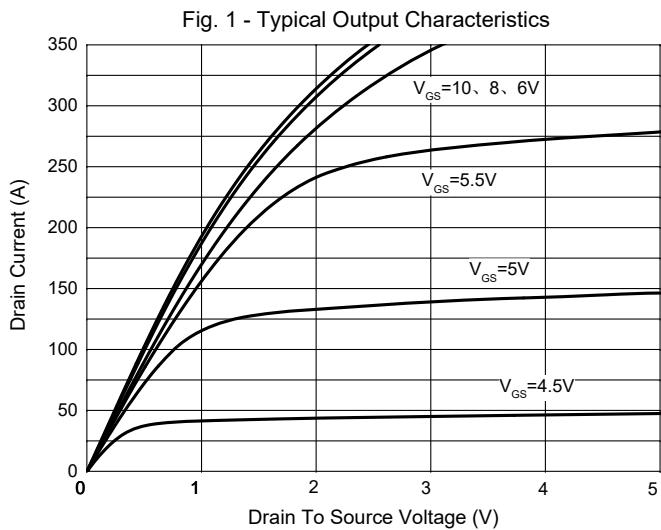
Suggested Solder Pad Layout



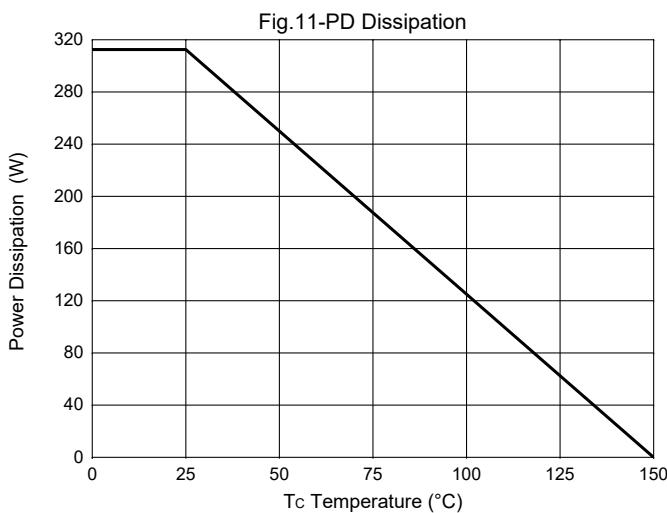
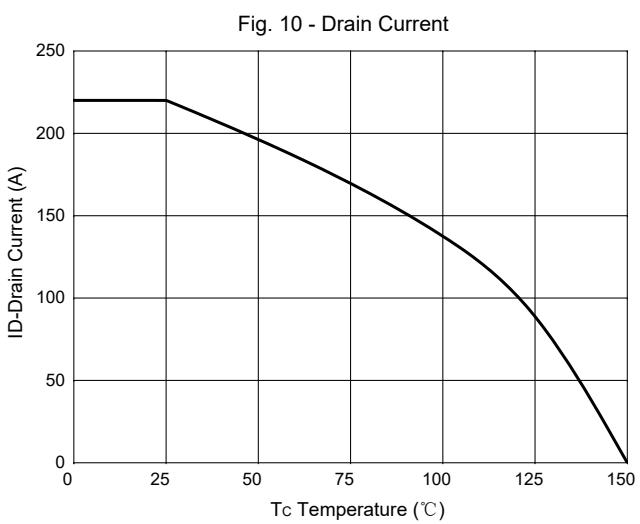
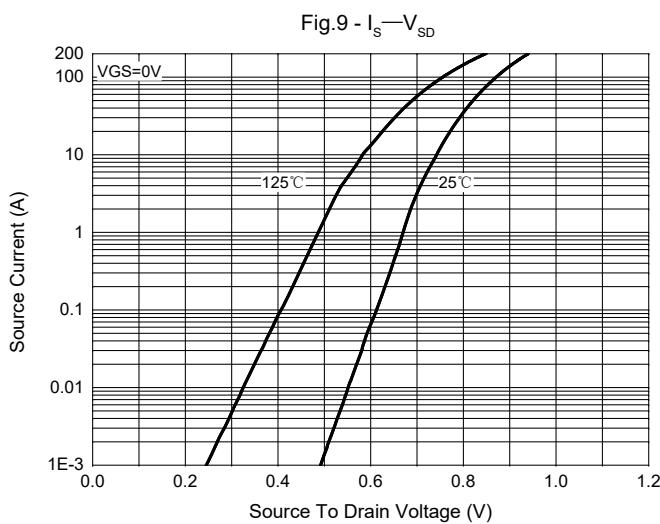
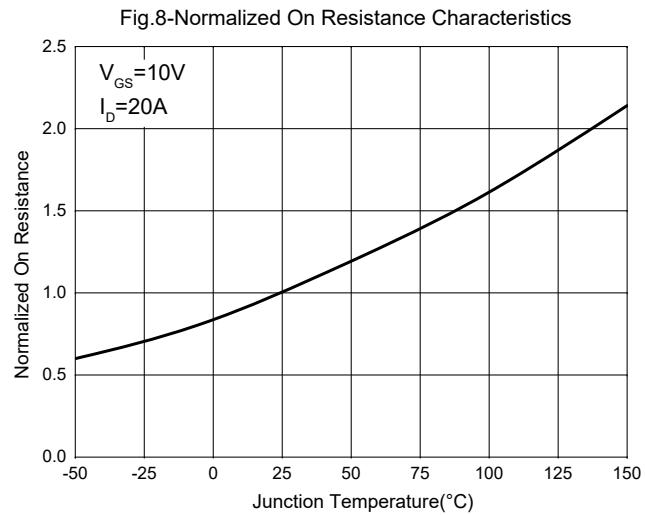
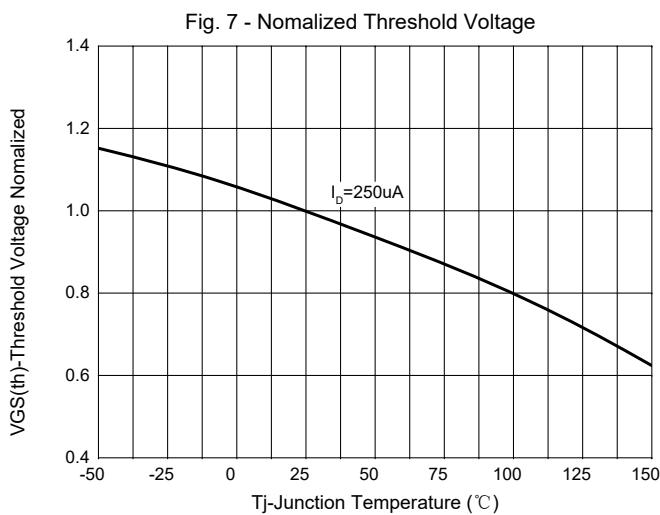
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=150V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		5	6.5	$m\Omega$
		$V_{GS}=6V, I_D=20A$		5.7	8	
Gate Resistance	R_g	f=1 MHz, Open drain		1.8		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				220	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=20A$			1.3	V
Reverse Recovery Time	t_{rr}	$I_S=110A, di/dt=540A/\mu s$		86		ns
Reverse Recovery Charge	Q_{rr}			2		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V, f=1MHz$		9177		pF
Output Capacitance	C_{oss}			598		
Reverse Transfer Capacitance	C_{rss}			23		
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V, I_D=110A$		155		nC
Gate-Source Charge	Q_{gs}			38		
Gate-Drain Charge	Q_{gd}			51		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=10V, V_{DD}=75V, I_D=110A, R_{GEN}=2.2\Omega$		30		ns
Turn-On Rise Time	t_r			259		
Turn-Off Delay Time	$t_{d(off)}$			65		
Turn-Off Fall Time	t_f			16		

Curve Characteristics



Curve Characteristics



Curve Characteristics

Fig. 12 - Safe Operation Area

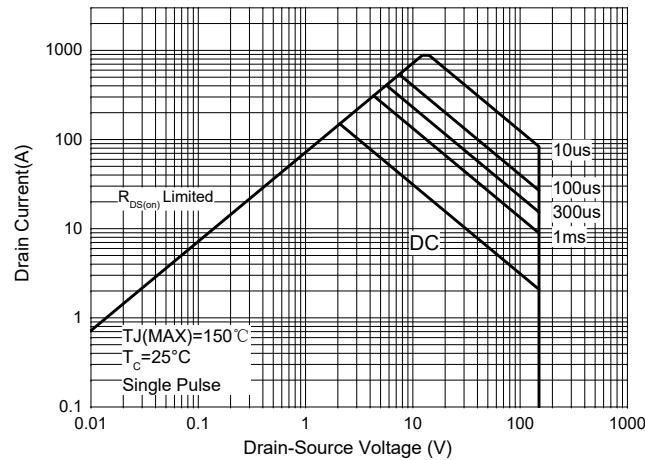
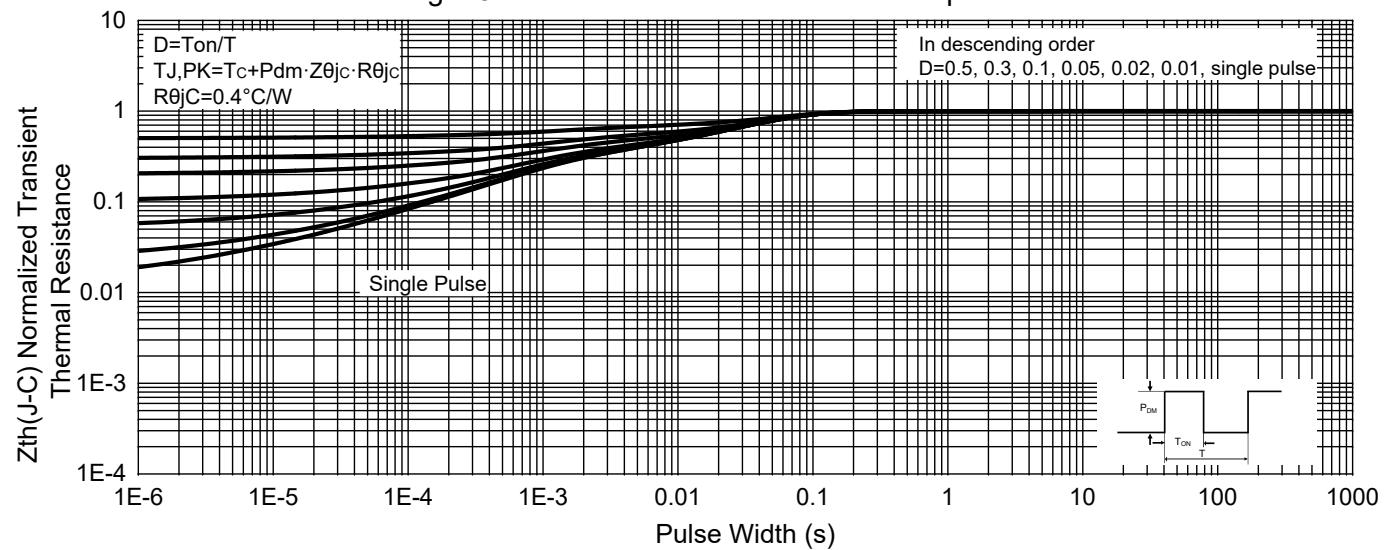


Fig. 13 -Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 800pcs/Reel

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